In the claims:

- 1-18. (Canceled)
- substrate received in the first housing, the substrate comprising: a first housing; a substrate received in the first housing, the substrate comprising a number of regions; a first DC bus bar comprising a first set of terminals, the first DC bus bar received at least partially in the first housing with the first set of terminals accessible from an exterior thereof; a second DC bus bar comprising a second set of terminals, the second DC bus bar received at least partially in the first housing with the second set of terminals accessible from an exterior thereof; a number of switches mounted to at least some of the regions of the substrate and electrically coupled to one another to form a bridge circuit electrically coupled between the first and the second DC bus bars; a first film capacitor disposed in the exterior of the first housing and electrically coupled across the terminals of the first housing and electrically coupled across the terminals of the first housing and electrically coupled across the terminals of the first and the second DC bus bars; and The power converter of claim 18

further comprising a first DC interconnect electrically coupling an anode of the first film capacitor to an anode of the second capacitor; and a second DC interconnect electrically coupling a cathode of the first capacitor to a cathode of the second film capacitor.

20. (ORIGINAL) The power converter of claim 19 further comprising: a second housing receiving the first housing, the first film capacitor and the second film

capacitor.

21-23. (Canceled)